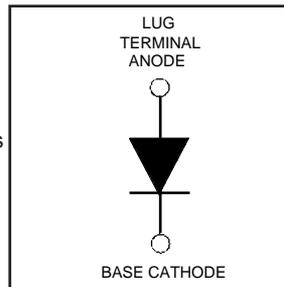


# HFA180NH40

Ultrafast, Soft Recovery Diode

## Features

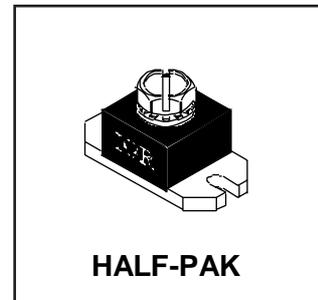
- Reduced RFI and EMI
- Reduced Snubbing
- Extensive Characterization of Recovery Parameters



$V_R = 400V$
$V_F(\text{typ.})^{\text{Ⓢ}} = 1.1V$
$I_{F(AV)} = 180A$
$Q_{rr}(\text{typ.}) = 420nC$
$I_{RRM}(\text{typ.}) = 8.7A$
$t_{rr}(\text{typ.}) = 45ns$
$di_{(rec)M}/dt(\text{typ.})^{\text{Ⓢ}} = 280A/\mu s$

## Description

HEXFRED™ diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and di/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.



## Absolute Maximum Ratings

	Parameter	Max.	Units
$V_R$	Cathode-to-Anode Voltage	400	V
$I_F @ T_C = 25^\circ C$	Continuous Forward Current	321	A
$I_F @ T_C = 100^\circ C$	Continuous Forward Current	160	
$I_{FSM}$	Single Pulse Forward Current ①	1200	
$I_{AS}$	Maximum Single Pulse Avalanche Current ②	5.0	mJ
$E_{AS}$	Non-Repetitive Avalanche Energy ②	1.4	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	625	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	250	
$T_J$	Operating Junction and	-55 to +150	°C
$T_{STG}$	Storage Temperature Range		

## Thermal - Mechanical Characteristics

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	0.20	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	—	0.15	—	K/W
Wt	Weight	—	26 (0.9)	—	g (oz)
	Mounting Torque	15 (1.7)	—	25 (2.8)	lbf·in
	Terminal Torque	20 (2.2)	—	40 (4.4)	(N·m)

**Note:** ① Limited by junction temperature  
 ② L = 100μH, duty cycle limited by max  $T_J$   
 ③ 125°C

# HFA180NH40

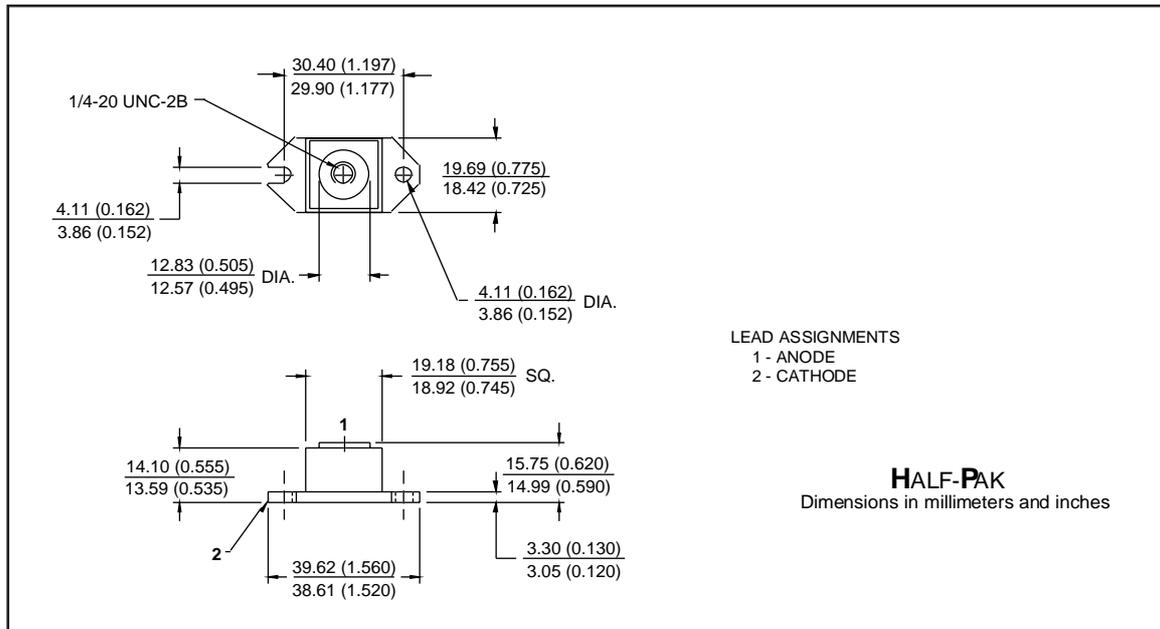
International  
**IOR** Rectifier

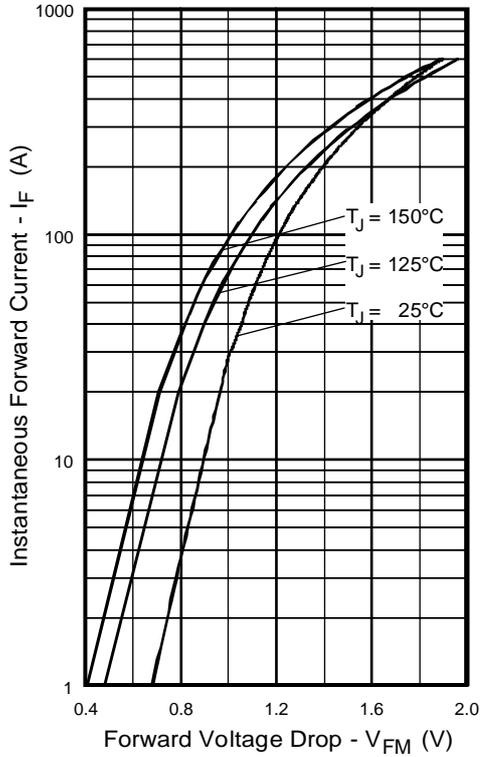
## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
V <sub>BR</sub>	Cathode Anode Breakdown Voltage	400	—	—	V	I <sub>R</sub> = 100μA
V <sub>FM</sub>	Max Forward Voltage	—	1.10	1.35	V	I <sub>F</sub> = 180A
		—	1.40	1.65		I <sub>F</sub> = 360A
		—	1.10	1.30		I <sub>F</sub> = 180A, T <sub>J</sub> = 125°C
I <sub>RM</sub>	Max Reverse Leakage Current	—	2.0	12	μA	V <sub>R</sub> = V <sub>R</sub> Rated
		—	3.0	16	mA	T <sub>J</sub> = 125°C, V <sub>R</sub> = 320V
C <sub>T</sub>	Junction Capacitance	—	370	500	pF	V <sub>R</sub> = 200V
L <sub>S</sub>	Series Inductance	—	5.0	—	nH	From top of terminal hole to mounting plane

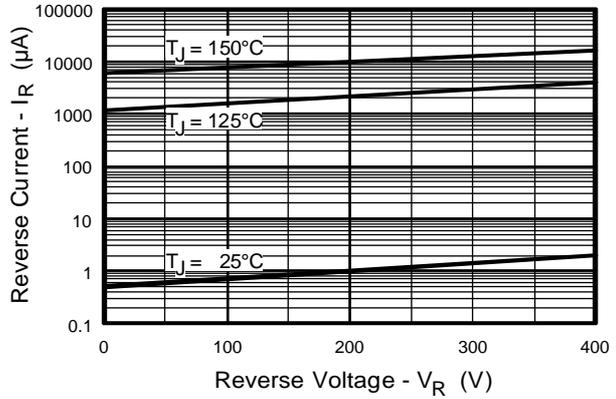
## Dynamic Recovery Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
t <sub>rr</sub>	Reverse Recovery Time	—	45	—	ns	I <sub>F</sub> = 1.0A, di <sub>F</sub> /dt = 200A/μs, V <sub>R</sub> = 30V
t <sub>rr1</sub>		—	90	140		T <sub>J</sub> = 25°C
t <sub>rr2</sub>		—	290	440		T <sub>J</sub> = 125°C
I <sub>RRM1</sub>	Peak Recovery Current	—	8.7	20	A	T <sub>J</sub> = 25°C
I <sub>RRM2</sub>		—	18	30		T <sub>J</sub> = 125°C
Q <sub>rr1</sub>	Reverse Recovery Charge	—	420	1100	nC	T <sub>J</sub> = 25°C
Q <sub>rr2</sub>		—	2600	7000		T <sub>J</sub> = 125°C
di <sub>(rec)M</sub> /dt1	Peak Rate of Fall of Recovery Current During t <sub>b</sub>	—	300	—	A/μs	T <sub>J</sub> = 25°C
di <sub>(rec)M</sub> /dt2		—	280	—		T <sub>J</sub> = 125°C

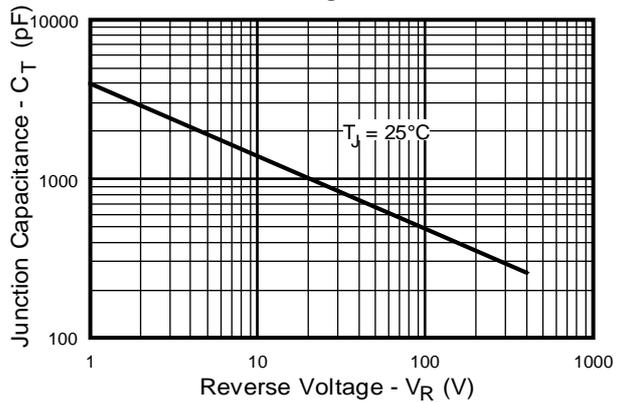




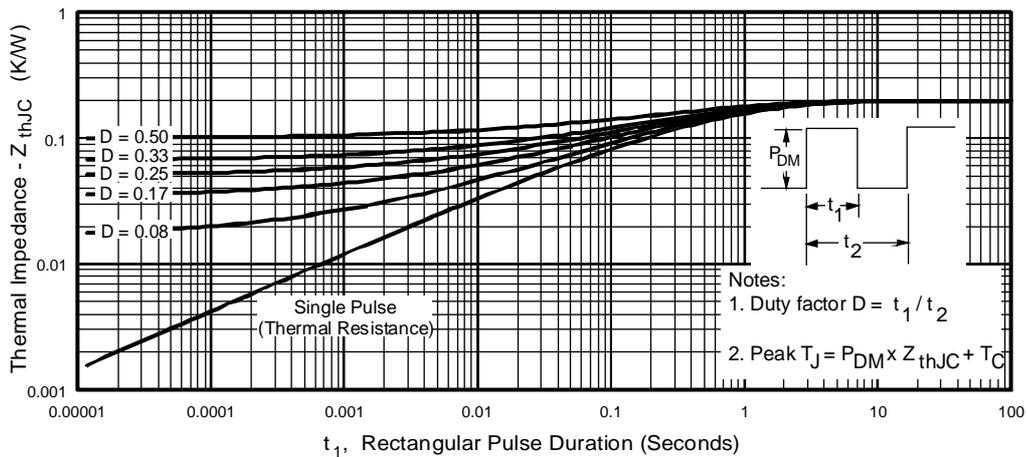
**Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current**



**Fig. 2 - Typical Reverse Current vs. Reverse Voltage**



**Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage**



**Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics**

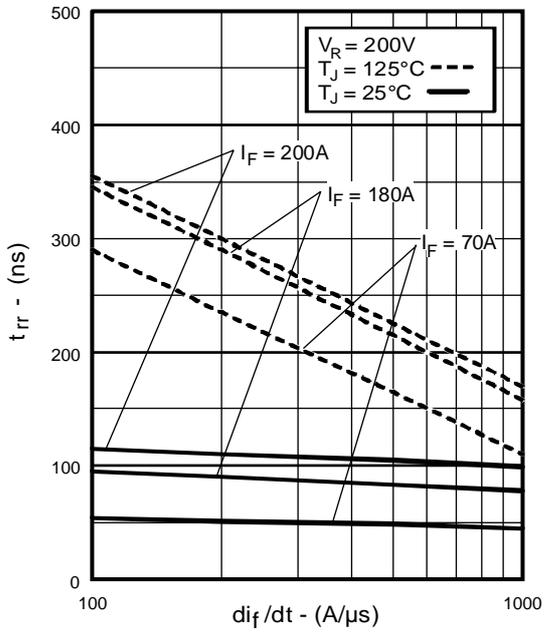


Fig. 5 - Typical Reverse Recovery vs.  $di_f/dt$

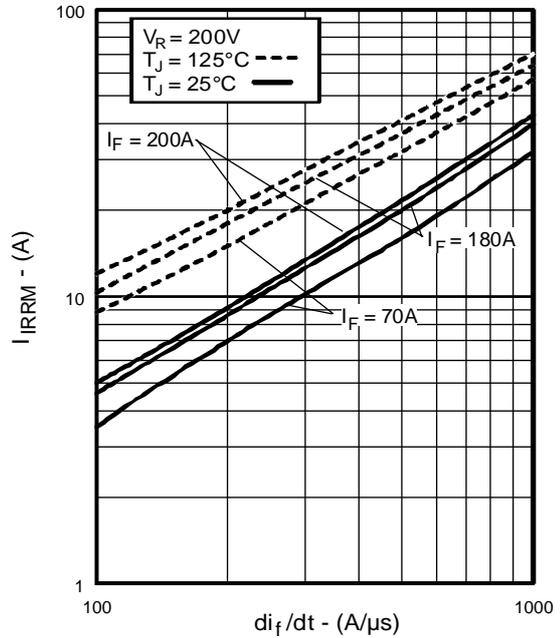


Fig. 6 - Typical Recovery Current vs.  $di_f/dt$

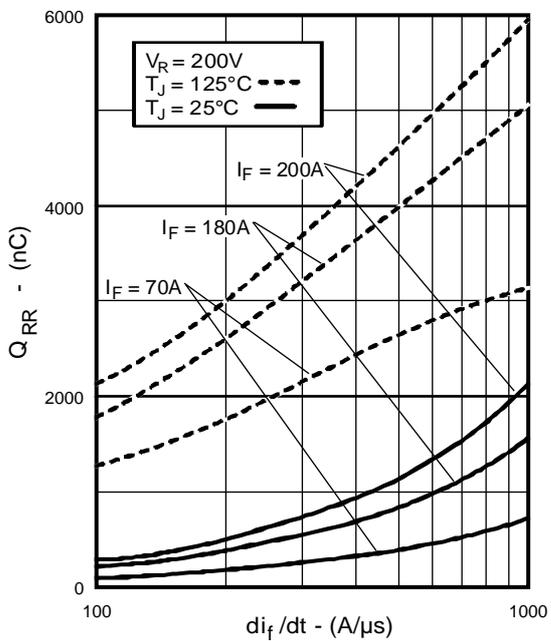


Fig. 7 - Typical Stored Charge vs.  $di_f/dt$

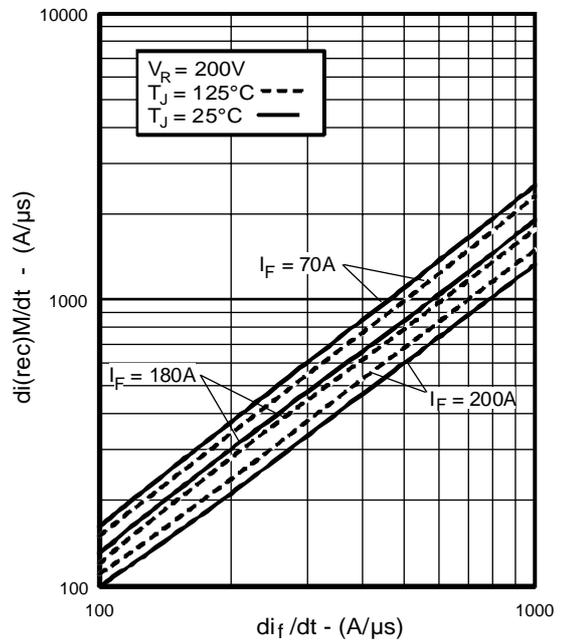
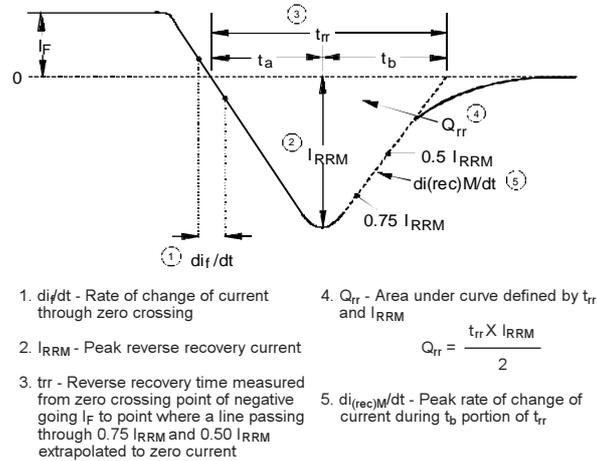
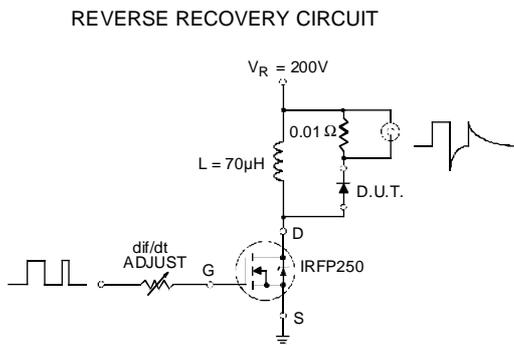
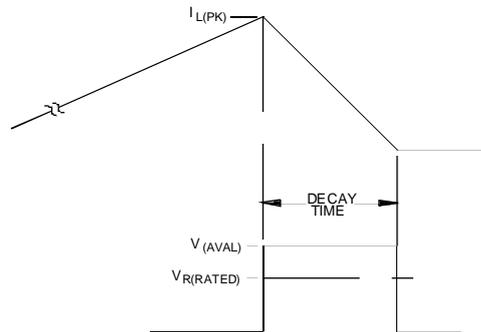
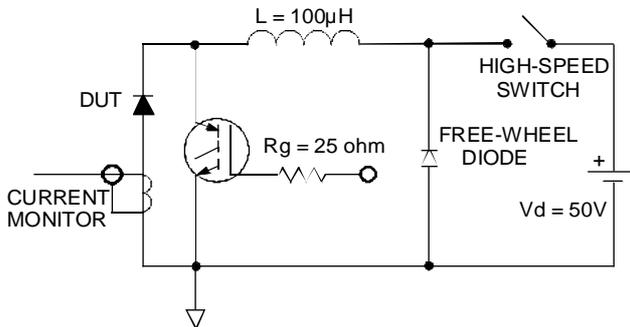


Fig. 8 - Typical  $di_{(rec)M}/dt$  vs.  $di_f/dt$



**Fig. 9 - Reverse Recovery Parameter Test Circuit**

**Fig. 10 - Reverse Recovery Waveform and Definitions**



**Fig. 11 - Avalanche Test Circuit and Waveforms**